



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00203	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = ASSEMBLY BOTTOM	CAN-to-Ethernet Converter		
PLOT NAME=Bottom Assembly Drawing	GENERATED:	12/16/2014 12:12:45 PM	TEXAS INSTRUMENTS

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